

MOSFETs Silicon N-channel MOS (U-MOSVIII)

TPN2R503NC

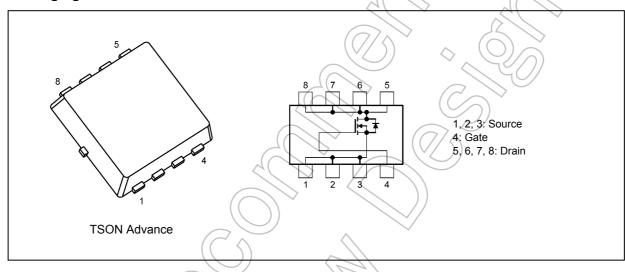
1. Applications

· Power Management Switches

2. Features

- (1) Small footprint due to a small and thin package
- (2) Low drain-source on-resistance: $R_{DS(ON)} = 2.1 \text{ m}\Omega$ (typ.) ($V_{GS} = 10 \text{ V}$)
- (3) Low leakage current: I_{DSS} = 10 μA (max) (V $_{DS}$ = 30 V)
- (4) Enhancement mode: $V_{th} = 1.3 \text{ to } 2.3 \text{ V (V}_{DS} = 10 \text{ V}, I_D = 0.5 \text{ mA)}$

3. Packaging and Internal Circuit





4. Absolute Maximum Ratings (Note) (Ta = 25°C unless otherwise specified)

Characterist	ics		Symbol	Rating	Unit
Drain-source voltage			V_{DSS}	30	V
Gate-source voltage			V_{GSS}	±20	
Drain current (DC)	(Silicon limit)	(Note 1), (Note 2)	I _D	85	Α
Drain current (DC)		(Note 1)	I _D	40	
Drain current (pulsed)	(t = 1 ms)	(Note 1)	I _{DP}	120	
Power dissipation	$(T_c = 25^{\circ}C)$		P _D	35	W
Power dissipation	(t = 10 s)	(Note 3)	Pp	1.9	W
Power dissipation	(t = 10 s)	(Note 4)	P_{D}	0.7	W
Single-pulse avalanche energy		(Note 5)	Eas	62	mJ
Avalanche current			(I _{AR})	40	Α
Channel temperature		6	T _{ch}	150	°C
Storage temperature		Al	Tstg	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteristics			Symbol	Max	Unit
Channel-to-case thermal resistance	(T _c = 25°C)		R _{th(ch-c)}	3.57	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 3)	R _{th(ch-a)}	65.7	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 4)	R _{th(ch-a)}	178	°C/W

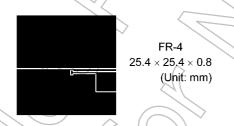
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: Limited by silicon capability. Package limit is 45 A.

Note 3: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 4: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 5: V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 30 μ H, R_G = 1 Ω , I_{AR} = 40 A



FR-4 $25.4 \times 25.4 \times 0.8$ (Unit: mm)

Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)

Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.



6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±0.1	μΑ
Drain cut-off current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V		_	10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	30			V
Drain-source breakdown voltage (Note 6)	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	15) b		
Gate threshold voltage	V_{th}	V _{DS} = 10 V, I _D = 0.5 mA	1.3	<i>7</i> _	2.3	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 4.5 V, I _D = 20 A	/ A	3.2	4.1	mΩ
		V _{GS} = 10 V, I _D = 20 A	\mathcal{L}	2.1	2.5	

Note 6: If a reverse bias is applied between gate and source, this device enters V_{(BR)DSX} mode. Note that the drain-source breakdown voltage is lowered in this mode.

6.2. Dynamic Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	> Max	Unit
Input capacitance	C _{iss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz) _ (2230) —	pF
Reverse transfer capacitance	C _{rss}			160/	_	
Output capacitance	C _{oss}			650	_	
Switching time (rise time)	t _r	See Figure 6.2.1.	/))	9	_	ns
Switching time (turn-on time)	t _{on}		\sim	14		
Switching time (fall time)	t _f))—	24	_	
Switching time (turn-off time)	t _{off}		_	68		

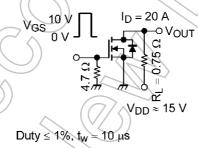


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 40 \text{ A}$		40		nC
Gate-source charge 1	Q _{gs1}			10		
Gate-drain charge	Q_{gd}			10		

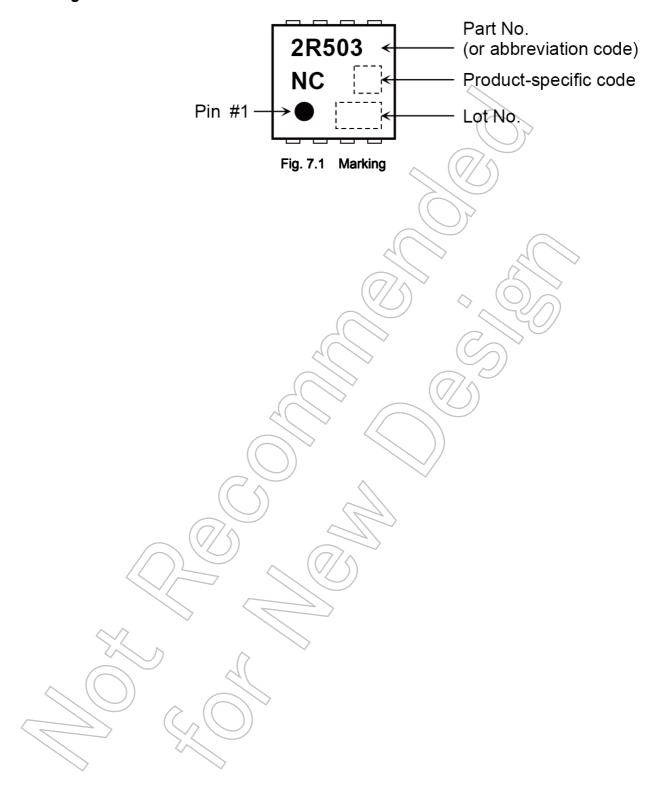
6.4. Source-Drain Characteristics (T_a = 25°C unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed)	(Note 7)	I _{DRP}	_	_	_	120	Α
Diode forward voltage		V_{DSF}	I _{DR} = 40 A, V _{GS} = 0 V			-1.2	V

Note 7: Ensure that the channel temperature does not exceed 150°C.

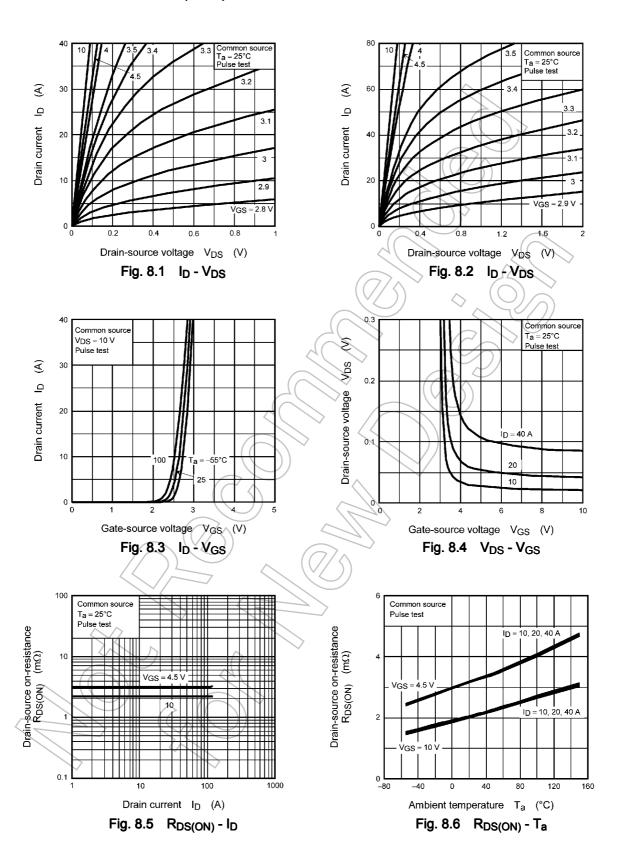


7. Marking



Rev.5.0

8. Characteristics Curves (Note)



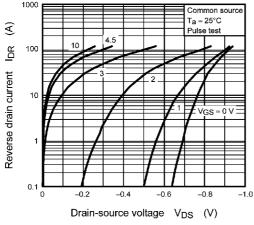


Fig. 8.7 I_{DR} - V_{DS}

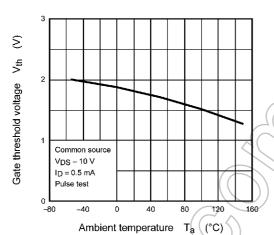


Fig. 8.9 V_{th} - T_a

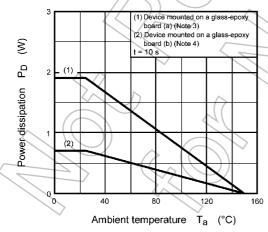


Fig. 8.11 P_D - T_a (Guaranteed Maximum)

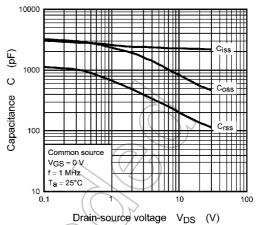


Fig. 8.8 Capacitance - V_{DS}

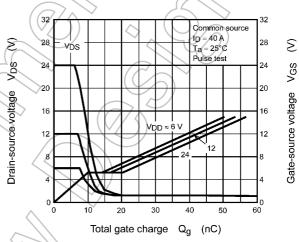


Fig. 8.10 Dynamic Input/Output Characteristics

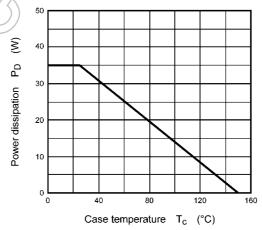


Fig. 8.12 P_D - T_c (Guaranteed Maximum)

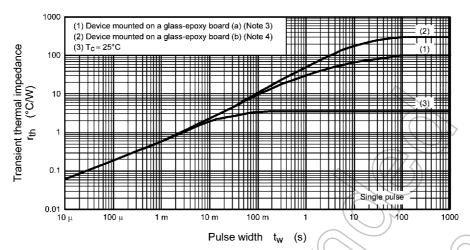


Fig. 8.13 r_{th} - t_w (Guaranteed Maximum)

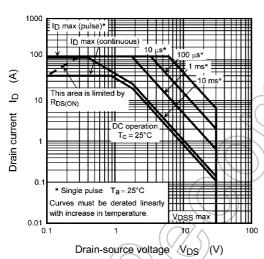


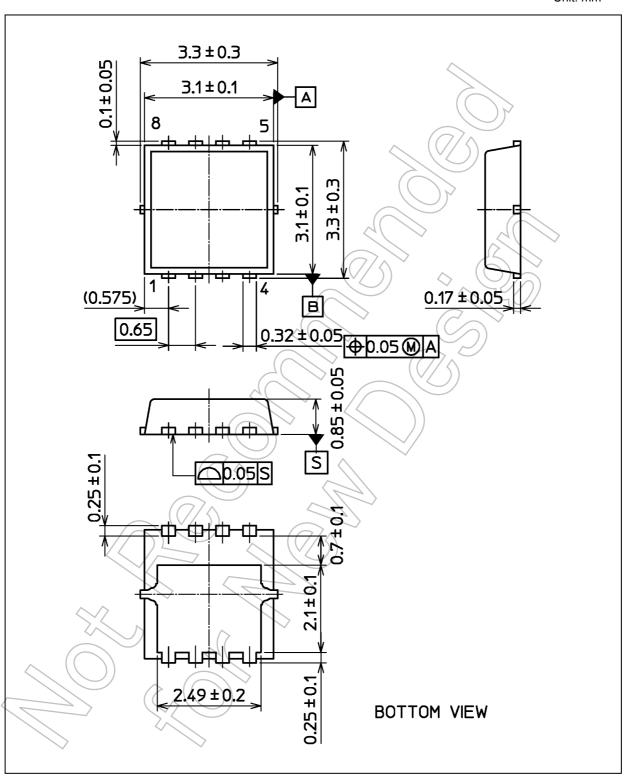
Fig. 8.14 Safe Operating Area (Guaranteed Maximum)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.02 g (typ.)

Package Name(s)
TOSHIBA: 2-3X1S
Nickname: TSON Advance

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